

Manufacturer Information

Company:	Azoteq(Pty) Ltd
	109 Main Road
	Paarl
	Western Cape
	Republic of South Africa

Product Information

Product:	IQS158 MSR
Package type:	MSOP/10LD
Manufacturing site:	Anst
Weight:	27.09
Unit:	mg

Authorised Representative

Name:	Anton Walles
Title:	Senior Logistics Engineer
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Manufacturing Process Information

Terminal Plating:	Refer to table below
J-STD MSL Rating:	1
Peak Process Body Temp:	260 °C
Max Time at Peak Temp:	25 sec
Number of Reflow:	3

Note: 'z' in the product description refers to a user configuration option

RoHS Material Composition Declaration

Azoteq hereby declares full compliance for the product listed above with the requirements of European Directive 2011/65/EU Article 7 and that this declaration is made in compliance with Article 13 of the Directive.

This declaration of conformity is issued under the sole responsibility of the manufacturer

Note: RoHS Directive 2011/65/EU of the European Parliament quantity limit of 0.1% by mass(1000 PPM) in homogeneous material for Lead(PB), Mercury, Hexavalent Chromium, Polybrominated Biphenysl(PBB), Polybrominated Diphenyl Ethers(PBDE) and quantity limit of 0.01% by mass(100 PPM) of homogeneous material of Cadmium applies to this declaration.

The full materials composition information follows:



Homogenio	us material con	nposition fo	r part: IQS158	3 MSR based on package: MSC	DP/10LD with D	ie: AZQ14	5									
Composition Part	Material name	Material (weight)	Material % (weight)	Element name composition	CAS No.	Element % (weight)	Element (weight)	Cd (ppm)	Pb (ppm)	Hg(pp m)	Cr+6(p pm)	PBBs	PBDEs	CI	Br	EU ROHS Exempt
Die	AZQ145	1.74	6.43%	Si Die	7440-21-3	100.00%	1.74	ND	ND	ND	ND	ND	ND	-	-	-
Ероху		0.04	0.15%	Copper(II) oxide	1317-38-0	5.00%	0.00	ND	ND	ND	ND	ND	ND	-	-	-
				Epoxy resin, epichlorohydrin-dimer fatty acid	68475-94-5	5.00%	0.00									
				Silver	7440-22-4	64.10%	0.03									
				Epichlorohydrin-formaldehyde- phenol copolymer	9003-36-5	5.00%	0.00									
				Poly(oxypropylene)diamine	9046-10-0	5.00%	0.00									
				Butyrolactone, gamma-	96-48-0	5.00%	0.00									
				Organosilane (Trade Secret - 10001)	TS ref# 10001	5.00%	0.00									
				Epoxy resin modifier (Trade Secret - 10038)	TS ref# 10038	0.90%	0.00									
				2,6-Diglycidyl phenyl allyl ether oligomer	UNASSIGNED	5.00%	0.00									
Leadframe	MSOP 10	8.32	30.70%	Mg	7439-95-4	0.10%	0.01	ND	7	ND	Negativ e	ND	ND	-	-	-
				Ni	7440-02-0	2.21%	0.18									
				Si	7440-21-3	0.65%	0.05									
				Ag	7440-22-4	1.29%	0.11									
				Cu	7440-50-8	95.75%	7.96									
Mold Compound		16.50	60.91%	Carbon Black	1333-86-4	1.00%	0.17	ND	ND	ND	ND	ND	ND	-	-	-
				Epoxy Resin B	29690-82-2	4.00%	0.66									
				Silica (Amorphous)	60676-86-0	81.00%	13.37									
				Epoxy Resin A	Trade secret A	10.00%	1.65									
				Phenol Resin	Trade secret B	4.00%	0.66									
Plating	Tin	0.35	1.29%	Sn	7440-31-5	99.99%	0.35	ND	17	ND	Negativ e	ND	ND	-	-	-
				Other	N/A	0.01%	0.00									



Composition Part	Material name	Material (weight)	Material % (weight)	Element name composition	CAS No.	Element % (weight)		Cd (ppm)	Pb (ppm)	Hg(pp m)	Cr+6(p pm)	PBBs	PBDEs	CI	Br	EU ROHS Exempt
Wire	Gold	0.14	0.51%	Au	7440-57-5	99.99%	0.14	ND	ND	ND	Negativ e	ND	ND	-	-	-
				Other	N/A	0.01%	0.00									

Note: Where the product is an assembly with lower level parts, the declaration encompasses all lower level materials for which

the manufacturer has engineering responsibility.

Signed:Anton Walles:Position:Senior Logistics Engineer





AZOTEQ (PTY) LIMITED

Date:

2012/10/31

